



INSTRUCTIONS FOR FITTING PHONO MODULE TO G02

This sheet is for the installation of a pair moving coil or moving magnet phono modules to a G02 Analogue controller.

WARNINGS

1. Power cord must be disconnected before case is removed.
2. Static sensitive parts are revealed when fitting a phono module. Ensure all antistatic precautions are taken !

TOOLS REQUIRED

3mm Hex Key
No.1 Phillips screwdriver
5mm Flat Blade Screwdriver
Anti-Static Bench Kit
T10 Torx driver

PROCEDURE

1. With the product placed on a flat surface, remove the four M5 Hex head screws using a 3mm Hex key.
2. Lift off the Outer lid.
3. Remove the seventeen M3 Phillips countersunk screws.
4. Lift off the inner lid, complete with the attached glass.
5. The left and right hand gaskets may be left in place.
6. Place the opened unit flat on the bench with its front panel towards you.
7. Remove top Audio PCB by removing mounting screws. Rear panel mounting screws are T10 Torx head.
8. At the left hand end of the upper audio PCB, at the rear of the product, you will see a rectangle (roughly 26mm x 76mm) screened on the circuit board. This is where the module will be located.
9. Remove and retain the wire link between two of the pin holes. Retain this for future use.
10. Remove one of the phono modules from its packaging, taking care to handle it by its edges only. The 2 modules are identical.
11. Carefully locate the module above the 5 pin holes and 2 pillars.
12. Check that all the pins are straight, and that they are all correctly aligned over the holes.
13. GENTLY push the module down until the holes at either end of it are against the mounting pillars. IF ANY RESISTANCE IS ENCOUNTERED, CHECK THAT THE PINS ARE CORRECTLY SITED AND ARE NOT BENDING, AS THIS WILL DAMAGE THE PRODUCT.
14. Secure the module with the hex headed screws and brass washers provided. NB THESE SCREWS SHOULD BE TIGHTENED CAREFULLY AS THEY PROVIDE GROUNDING FOR THE MODULE AS WELL AS FIXING.
15. Check that the module is secure and that all pins are sited correctly.
16. Refit the top Audio PCB, and repeat steps 8 to 15 for the second module on the top Audio PCB.
17. Refit the lid to the chassis by reversing steps 1 to 4.